

## ELCA SPECIAL RECTIFIERS FOR HARD CHROMIUM (type PRP – PRPR)

The process (covered by European patent) is based on the use of **periodic reversing polarity** that allows to get a completely **crack-free** layer and therefore the **resistance to corrosion is very high**.

However the **hardness and elasticity (resistance to thermal and mechanical shocks)** are **lower** in comparison with the ones obtained by means of conventional direct current.

In order to get a high resistance to corrosion and high hardness and elasticity, a **double or multilayer** deposit system is used.

**A first layer**, usually touching the base metal, must be obtained by means of periodic reversing polarity; **a second layer** must be superimposed by means of conventional direct current on the first layer (**high elasticity and hardness** even if cracked).

The cracks of the second layer do not reach the base metal thanks to the first crack-free layer.

**In conclusion it is the first layer which is important for provision of resistance to corrosion whilst the second layer provides the hardness and elasticity of the deposit.**

### PRACTICAL ADVICE TO GET MULTILAYER DEPOSITS

Before starting to superpose different layers with different features it is **very important to check if the preset parameters of periodic reversing polarity allow actually to obtain a crack-free deposit**.

Our advice is to carry out some preliminary tests by depositing only one layer with periodic reversing polarity, according to the instructions here below:

#### To obtain a crack-free layer

The rectifier must work all treatment long with periodic reversing polarity:

The parameter **recommended values** are the following:

- Interval between 2 negative pulses (**PIC POS**) = **15 sec.** (D)
- Duration **PIC NEG** = **10÷12 centisec.** (E)
- Amplitude (%) **PIC NEG** = **50%** (B) (only if equipped with ELCA RAMPER)

As a rule a small crack-free deposit (4 ÷ 8 micron) is enough to get a good resistance to corrosion.

If possible no mechanical working must be carried out after the end of the process and before checking the resistance to corrosion.

If some **cracks** (which can cause an low resistance to corrosion) **are still present**, you can try to decrease the number of them or to eliminate them , as follows:

- **Increasing** negative pulse duration (PIC NEG) .  
This value can be increased up to 20÷30 centisec.
- **Decreasing** the interval between 2 negative pulses (PIC POS) .This value can be decreased step by step up to 2÷5 sec. (till some adhesion problems occur).

After **checking the actual increasing in the resistance to corrosion** compared with the values obtained with conventional direct current, it is possible to carry out a **second layer using direct current**.

**To get a multilayer deposit:**

- Start depositing a **first crack-free layer (few microns with periodic reversing polarity** using the working parameters checked in the previous tests).
- Superpose a **second layer (cracked)** which completes the thickness of the layer which is obtained using **direct current**.

Carry out the following tests: hardness, resistance to corrosion, elasticity and **compare them with the ones obtained by means of conventional deposit by using direct current**.

Increase step by step the thickness of the crack-free layer till the optimum compromise value is reached according to the quality of the deposit you need (resistance to corrosion, hardness).

**In conclusion it is the first layer which is important for provision of resistance to corrosion whilst the second layer provides the hardness and elasticity of the deposit .**

Four or multilayer deposits can be got alternating those obtained with periodic reversing polarity with those without periodic reversing polarity.

**SUPERPOSING OF POSITIVE PULSES**

The use of **positive pulses** superposed on the base level allows to obtain a **finer grain layer** .

**Hardness, throwing power and deposition rate** increase.

**The recommended values** in the working with **positive pulses** are:

- Base time = 3 centisec. (F)
- Pulse time = 3 centisec. (G)
- Pulse amplitude (%) = 30÷40% (C)

**WAVEFORMS AND PARAMETERS**